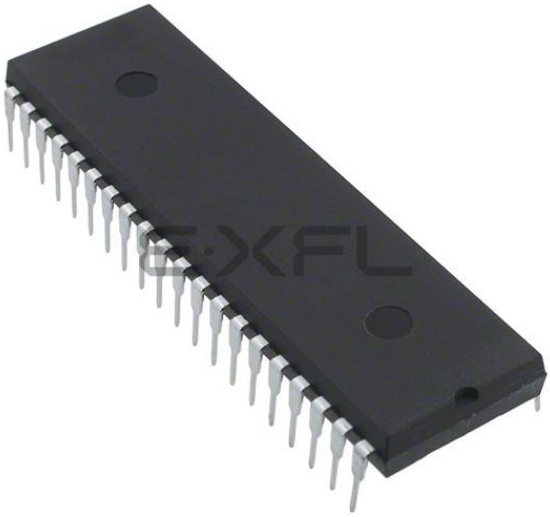

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	36
Program Memory Size	28KB (16K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 35x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.600", 15.24mm)
Supplier Device Package	40-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf18876-i-p

TABLE 1-3: PIC16F18876 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RC0/ANC0/T1CKI(1)/T3CKI(1)/T3G(1)/ SMTWIN1(1)/IOCC0/SOSCO	RC0	TTL/ST	CMOS/OD	General purpose I/O.
	ANC0	AN	—	ADC Channel C0 input.
	T1CKI(1)	TTL/ST	—	Timer1 external digital clock input.
	T3CKI(1)	TTL/ST	—	Timer3 external digital clock input.
	T3G(1)	TTL/ST	—	Timer3 gate input.
	SMTWIN1(1)	TTL/ST	—	Signal Measurement Timer1 (SMT1) input.
	IOCC0	TTL/ST	—	Interrupt-on-change input.
	SOSCO	—	AN	32.768 kHz secondary oscillator crystal driver output.
RC1/ANC1/SMTSIG1(1)/CCP2(1)/ IOCC1/SOSCI	RC1	TTL/ST	CMOS/OD	General purpose I/O.
	ANC1	AN	—	ADC Channel C1 input.
	SMTSIG1(1)	TTL/ST	—	Signal Measurement Timer1 (SMT1) signal input.
	CCP2(1)	TTL/ST	CMOS/OD	Capture/compare/PWM2 (default input location for capture function).
	IOCC1	TTL/ST	—	Interrupt-on-change input.
	SOSCI	AN	—	32.768 kHz secondary oscillator crystal driver input.
RC2/ANC2/T5CKI(1)/CCP1(1)/IOCC2	RC2	TTL/ST	CMOS/OD	General purpose I/O.
	ANC2	AN	—	ADC Channel C2 input.
	T5CKI(1)	TTL/ST	—	Timer5 external digital clock input.
	CCP1(1)	TTL/ST	CMOS/OD	Capture/compare/PWM1 (default input location for capture function).
	IOCC2	TTL/ST	—	Interrupt-on-change input.
RC3/ANC3/SCL1(3,4)/SCK1(1)/ T2IN(1)/IOCC3	RC3	TTL/ST	CMOS/OD	General purpose I/O.
	ANC3	AN	—	ADC Channel C3 input.
	SCL1(3,4)	I^2C/SMBus	OD	MSSP1 I^2C clock input/output.
	SCK1(1)	TTL/ST	CMOS/OD	MSSP1 SPI clock input/output (default input location, SCK1 is a PPS remappable input and output).
	T2IN(1)	TTL/ST	—	Timer2 external input.
	IOCC3	TTL/ST	—	Interrupt-on-change input.
RC4/ANC4/SDA1(3,4)/SDI1(1)/IOCC4	RC4	TTL/ST	CMOS/OD	General purpose I/O.
	ANC4	AN	—	ADC Channel C4 input.
	SDA1(3,4)	I^2C/SMBus	OD	MSSP1 I^2C serial data input/output.
	SDI1(1)	TTL/ST	—	MSSP1 SPI serial data input.
	IOCC4	TTL/ST	—	Interrupt-on-change input.
RC5/ANC5/T4IN(1)/IOCC5	RC5	TTL/ST	CMOS/OD	General purpose I/O.
	ANC5	AN	—	ADC Channel C5 input.
	T4IN(1)	TTL/ST	—	Timer4 external input.
	IOCC5	TTL/ST	—	Interrupt-on-change input.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open-Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I^2C = Schmitt Trigger input with I^2CHV= High Voltage XTAL= Crystal levels

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins. Refer to Table 13-1 for details on which PORT pins may be used for this signal.

2: All output signals shown in this row are PPS remappable. These signals may be mapped to output onto one of several PORTx pin options as described in Table 13-3.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. The SCLx/SDAx signals may be assigned to any of the RB1/RB2/RC3/RC4 pins. PPS assignments to the other pins (e.g., RA5) will operate, but input logic levels will be standard TTL/ST, as selected by the INLVL register, instead of the I^2C specific or SMBus input buffer thresholds.

REGISTER 4-5: CONFIG5: CONFIGURATION WORD 5: CODE PROTECTION

U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—
bit 13					bit 8

U-1	U-1	U-1	U-1	U-1	U-1	R/P-1	R/P-1
—	—	—	—	—	—	$\overline{CPD}$	$\overline{CP}$
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	x = Bit is unknown	U = Unimplemented bit, read as ‘1’
‘0’ = Bit is cleared	‘1’ = Bit is set	W = Writable bit	n = Value when blank or after Bulk Erase

bit 13-2 **Unimplemented:** Read as ‘1’

bit 1 **$\overline{CPD}$:** Data NVM (EEPROM) Memory Code Protection bit
- 1 = EEPROM code protection disabled
- 0 = EEPROM code protection enabled

bit 0 **$\overline{CP}$**: Program Flash Memory Code Protection bit
- 1 = Program Flash Memory code protection disabled
- 0 = Program Flash Memory code protection enabled

5.0 RESETS

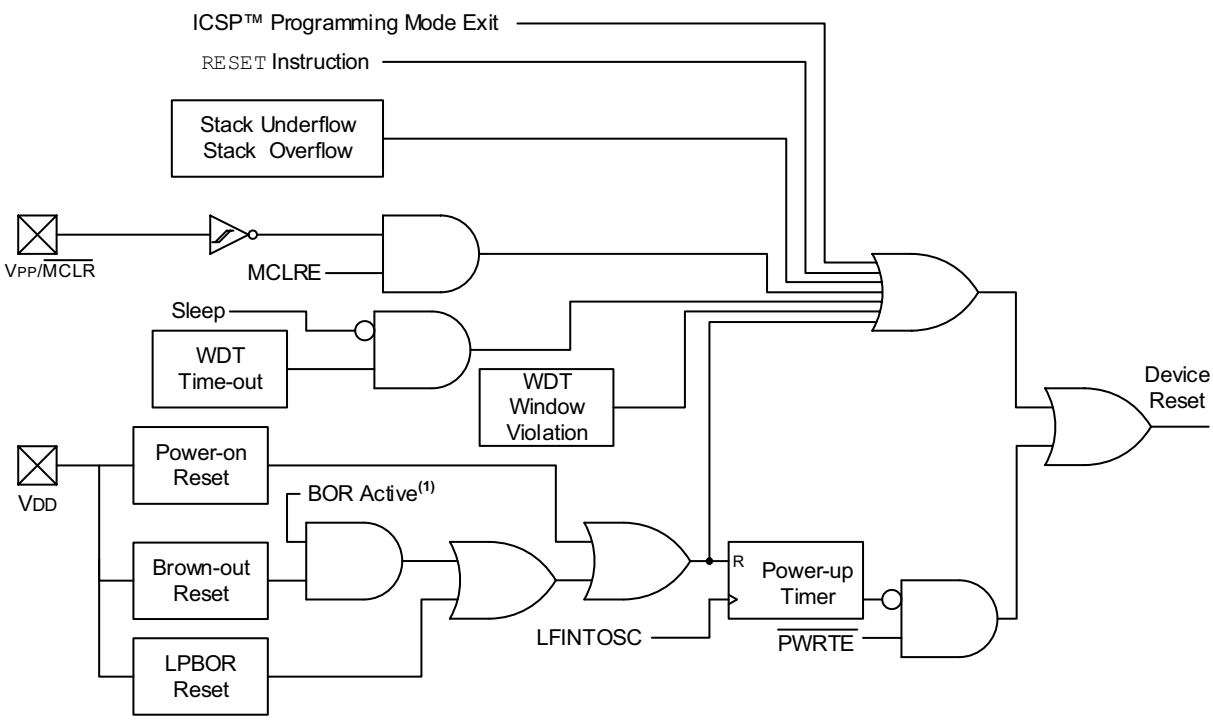
There are multiple ways to reset this device:

- Power-On Reset (POR)
- Brown-Out Reset (BOR)
- $\overline{\text{MCLR}}$ Reset
- WDT Reset
- RESET instruction
- Stack Overflow
- Stack Underflow
- Programming mode exit

To allow VDD to stabilize, an optional Power-up timer can be enabled to extend the Reset time after a BOR or POR event.

A simplified block diagram of the On-Chip Reset Circuit is shown in Figure 5-1.

FIGURE 5-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



Note 1: See Table 5-1 for BOR active conditions.

REGISTER 7-8: PIE6: PERIPHERAL INTERRUPT ENABLE REGISTER 6

U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	CCP5IE	CCP4IE	CCP3IE	CCP2IE	CCP1IE
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS = Hardware set

bit 7-5 **Unimplemented:** Read as '0'.

bit 4 **CCP5IE:** CCP5 Interrupt Enable bit
- 1 = CCP5 interrupt is enabled
- 0 = CCP5 interrupt is disabled

bit 3 **CCP4IE:** CCP4 Interrupt Enable bit
- 1 = CCP4 interrupt is enabled
- 0 = CCP4 interrupt is disabled

bit 2 **CCP3IE:** CCP3 Interrupt Enable bit
- 1 = CCP3 interrupt is enabled
- 0 = CCP3 interrupt is disabled

bit 1 **CCP2IE:** CCP2 Interrupt Enable bit
- 1 = CCP2 interrupt is enabled
- 0 = CCP2 interrupt is disabled

bit 0 **CCP1IE:** CCP1 Interrupt Enable bit
- 1 = CCP1 interrupt is enabled
- 0 = CCP1 interrupt is disabled

Note: Bit PEIE of the INTCON register must be set to enable any peripheral interrupt controlled by registers PIE1-PIE8.

12.12 PORTE Registers (PIC16(L)F18856)

12.12.1 DATA REGISTER

PORTE is a 4-bit wide, bidirectional port. The corresponding data direction register is TRISE (Register 12-42). Setting a TRISE bit (= 1) will make the corresponding PORTE pin an input (i.e., disable the output driver). Clearing a TRISE bit (= 0) will make the corresponding PORTE pin an output (i.e., enables output driver and puts the contents of the output latch on the selected pin). Example 12.4.9 shows how to initialize PORTE.

Reading the PORTE register (Register 12-42) reads the status of the pins, whereas writing to it will write to the PORT latch. All write operations are read-modify-write operations. Therefore, a write to a port implies that the port pins are read, this value is modified and then written to the PORT data latch (LATE).

12.12.2 INPUT THRESHOLD CONTROL

The INLVLE register (Register 12-44) controls the input voltage threshold for each of the available PORTE input pins. A selection between the Schmitt Trigger CMOS or the TTL Compatible thresholds is available. The input threshold is important in determining the value of a read of the PORTE register and also the level at which an interrupt-on-change occurs, if that feature is enabled. See Table 37-4 for more information on threshold levels.

Note:	Changing the input threshold selection should be performed while all peripheral modules are disabled. Changing the threshold level during the time a module is active may inadvertently generate a transition associated with an input pin, regardless of the actual voltage level on that pin.

12.12.3 WEAK PULL-UP CONTROL

The WPUE register (Register 12-43) controls the individual weak pull-ups for each port pin.

12.12.4 PORTE FUNCTIONS AND OUTPUT PRIORITIES

Each pin defaults to the PORT latch data after Reset. Other output functions are selected with the peripheral pin select logic. See **Section 13.0 "Peripheral Pin Select (PPS) Module"** for more information.

Analog input functions, such as ADC and comparator inputs, are not shown in the peripheral pin select lists. Digital output functions may continue to control the pin when it is in Analog mode.

12.12.5 PORTE FUNCTIONS AND OUTPUT PRIORITIES

Each pin defaults to the PORT latch data after Reset. Other output functions are selected with the peripheral pin select logic. See **Section 13.0 "Peripheral Pin Select (PPS) Module"** for more information.

Analog input functions, such as ADC and comparator inputs, are not shown in the peripheral pin select lists. Digital output functions may continue to control the pin when it is in Analog mode.

19.0 PULSE-WIDTH MODULATION (PWM)

The PWMx modules generate Pulse-Width Modulated (PWM) signals of varying frequency and duty cycle.

In addition to the CCP modules, the PIC16(L)F18855/75 devices contain two PWM modules (PWM6 and PWM7). These modules are essentially the same as the CCP modules without the Capture or Compare functionality.

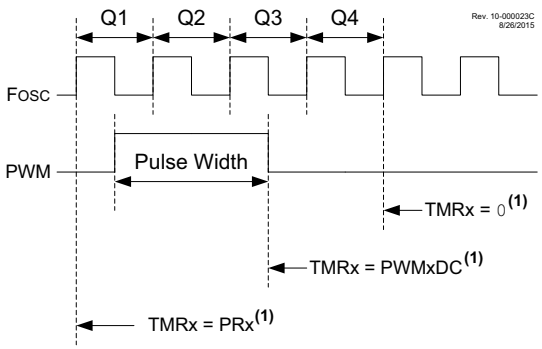
Note:	The PWM6 and PWM7 modules are two instances of the same PWM module design. Throughout this section, the lower case 'x' in register and bit names is a generic reference to the PWM module number (which should be substituted with 6 or 7 during code development). For example, the control register is generically described in this chapter as PWMxCON, but the actual device registers are PWM6CON and PWM7CON. Similarly, the PWMxEN bit represents the PWM6EN and PWM7EN bits.

Pulse-Width Modulation (PWM) is a scheme that provides power to a load by switching quickly between fully on and fully off states. The PWM signal resembles a square wave where the high portion of the signal is considered the 'on' state (pulse width), and the low portion of the signal is considered the 'off' state. The term duty cycle describes the proportion of the 'on' time to the 'off' time and is expressed in percentages, where 0% is fully off and 100% is fully on. A lower duty cycle corresponds to less power applied and a higher duty cycle corresponds to more power applied. The PWM period is defined as the duration of one complete cycle or the total amount of on and off time combined.

PWM resolution defines the maximum number of steps that can be present in a single PWM period. A higher resolution allows for more precise control of the pulse width time and, in turn, the power that is applied to the load.

Figure 19-1 shows a typical waveform of the PWM signal.

FIGURE 19-1: PWM OUTPUT



Note 1: Timer dependent on PWMTMRS register settings.

22.7 Register Definitions: CLC Control

REGISTER 22-1: CLCxCON: CONFIGURABLE LOGIC CELL CONTROL REGISTER

R/W-0/0	U-0	R-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
LCxEN	—	LCxOUT	LCxINTP	LCxINTN	LCxMODE<2:0>		
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **LCxEN:** Configurable Logic Cell Enable bit
1 = Configurable logic cell is enabled and mixing input signals
0 = Configurable logic cell is disabled and has logic zero output

bit 6 **Unimplemented:** Read as ‘0’

bit 5 **LCxOUT:** Configurable Logic Cell Data Output bit
Read-only: logic cell output data, after LCPOL; sampled from CLCxOUT

bit 4 **LCxINTP:** Configurable Logic Cell Positive Edge Going Interrupt Enable bit
1 = CLCxIF will be set when a rising edge occurs on CLCxOUT
0 = CLCxIF will not be set

bit 3 **LCxINTN:** Configurable Logic Cell Negative Edge Going Interrupt Enable bit
1 = CLCxIF will be set when a falling edge occurs on CLCxOUT
0 = CLCxIF will not be set

bit 2-0 **LCxMODE<2:0>:** Configurable Logic Cell Functional Mode bits
111 = Cell is 1-input transparent latch with S and R
110 = Cell is J-K flip-flop with R
101 = Cell is 2-input D flip-flop with R
100 = Cell is 1-input D flip-flop with S and R
011 = Cell is S-R latch
010 = Cell is 4-input AND
001 = Cell is OR-XOR
000 = Cell is AND-OR

25.6 Register Definitions: DAC Control

REGISTER 25-1: DAC1CON0: VOLTAGE REFERENCE CONTROL REGISTER 0

R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	R/W-0/0
DAC1EN	—	DAC1OE1	DAC1OE2	DAC1PSS<1:0>		—	DAC1NSS
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **DAC1EN:** DAC1 Enable bit
1 = DAC is enabled
0 = DAC is disabled

bit 6 **Unimplemented:** Read as '0'

bit 5 **DAC1OE1:** DAC1 Voltage Output 1 Enable bit
1 = DAC voltage level is also an output on the DAC1OUT1 pin
0 = DAC voltage level is disconnected from the DAC1OUT1 pin

bit 4 **DAC1OE2:** DAC1 Voltage Output 1 Enable bit
1 = DAC voltage level is also an output on the DAC1OUT2 pin
0 = DAC voltage level is disconnected from the DAC1OUT2 pin

bit 3-2 **DAC1PSS<1:0>:** DAC1 Positive Source Select bits
11 = Reserved, do not use
10 = FVR output
01 = V_{REF+} pin
00 = V_{DD}

bit 1 **Unimplemented:** Read as '0'

bit 0 **DAC1NSS:** DAC1 Negative Source Select bits
1 = V_{REF-} pin
0 = V_{SS}

REGISTER 25-2: DAC1CON1: VOLTAGE REFERENCE CONTROL REGISTER 1

U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	DAC1R<4:0>				
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **DAC1R<4:0>:** DAC1 Voltage Output Select bits
$V_{OUT} = (V_{SRC+} - V_{SRC-})*(DAC1R<4:0>/32) + V_{SRC}$

26.11 Register Definitions: Modulation Control

REGISTER 26-1: MDCON0: MODULATION CONTROL REGISTER

R/W-0/0	U-0	R/W-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0
MDEN	—	MDOUT	MDOPOL	—	—	—	MDBIT(2)
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **MDEN:** Modulator Module Enable bit
1 = Modulator module is enabled and mixing input signals
0 = Modulator module is disabled and has no output

bit 6 **Unimplemented:** Read as ‘0’

bit 5 **MDOUT:** Modulator Output bit
Displays the current output value of the modulator module.(1)

bit 4 **MDOPOL:** Modulator Output Polarity Select bit
1 = Modulator output signal is inverted; idle high output
0 = Modulator output signal is not inverted; idle low output

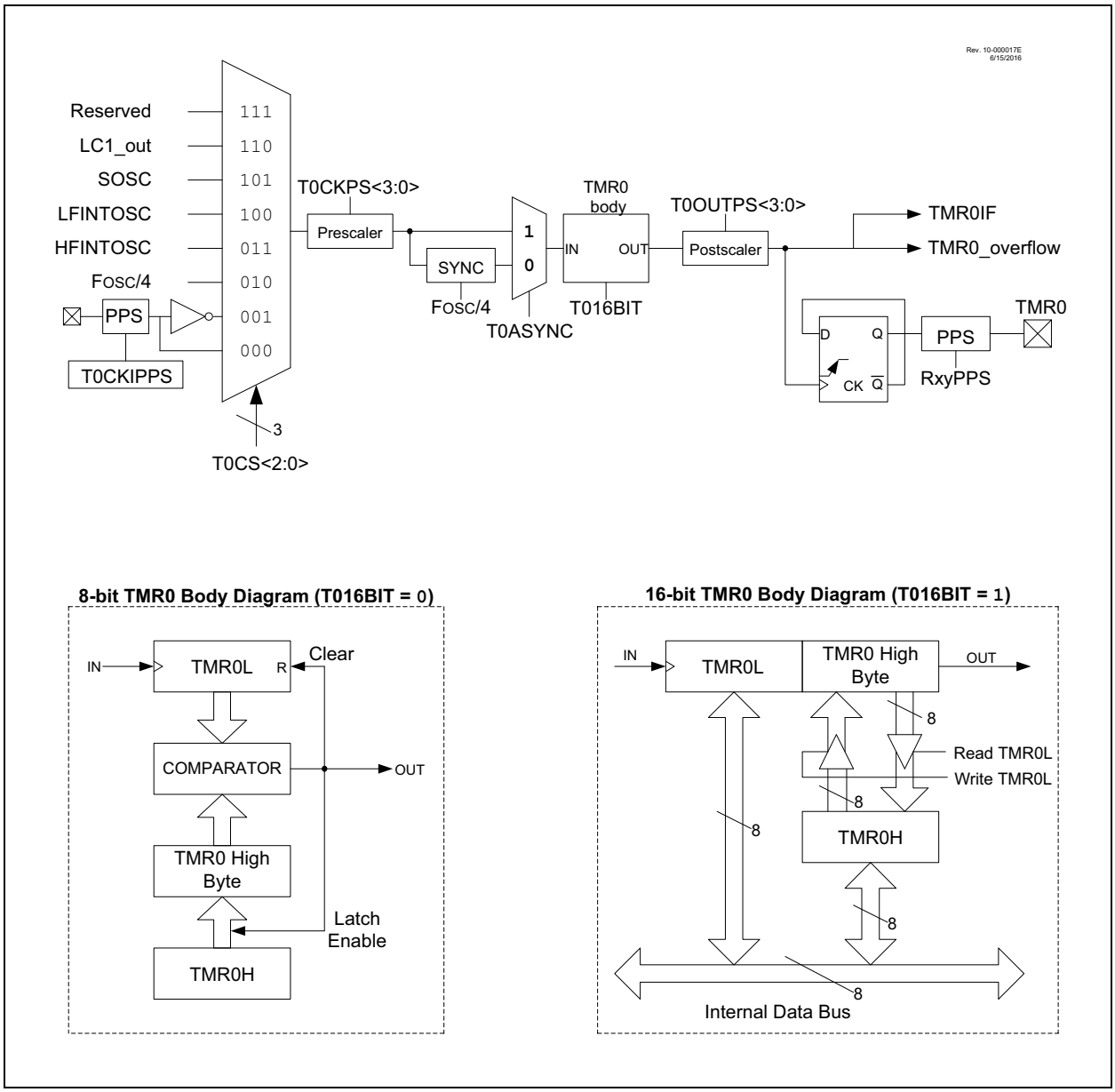
bit 3-1 **Unimplemented:** Read as ‘0’

bit 0 **MDBIT:** Allows software to manually set modulation source input to module(2)

Note 1: The modulated output frequency can be greater and asynchronous from the clock that updates this register bit, the bit value may not be valid for higher speed modulator or carrier signals.

2: MDBIT must be selected as the modulation source in the MDSRC register for this operation.

FIGURE 27-1: BLOCK DIAGRAM OF TIMER0



28.8 Timer1 Interrupts

The timer register pair (TMR1H:TMR1L) increments to FFFFh and rolls over to 0000h. When the timer rolls over, the respective timer interrupt flag bit of the PIR5 register is set. To enable the interrupt on rollover, you must set these bits:

- ON bit of the T1CON register
- TMR1IE bit of the PIE4 register
- PEIE bit of the INTCON register
- GIE bit of the INTCON register

The interrupt is cleared by clearing the TMR1IF bit in the Interrupt Service Routine.

Note:	To avoid immediate interrupt vectoring, the TMR1H:TMR1L register pair should be preloaded with a value that is not imminently about to rollover, and the TMR1IF flag should be cleared prior to enabling the timer interrupts.

28.9 Timer1 Operation During Sleep

Timer1 can only operate during Sleep when setup in Asynchronous Counter mode. In this mode, an external crystal or clock source can be used to increment the counter. To set up the timer to wake the device:

- ON bit of the T1CON register must be set
- TMR1IE bit of the PIE4 register must be set
- PEIE bit of the INTCON register must be set
- $\overline{\text{SYNC}}$ bit of the T1CON register must be set
- CLK bits of the T1CLK register must be configured
- The timer clock source must be enabled and continue operation during sleep. When the SOSC is used for this purpose, the SOSCEN bit of the OSCEN register must be set.

The device will wake-up on an overflow and execute the next instructions. If the GIE bit of the INTCON register is set, the device will call the Interrupt Service Routine.

Secondary oscillator will continue to operate in Sleep regardless of the $\overline{\text{SYNC}}$ bit setting.

28.10 CCP Capture/Compare Time Base

The CCP modules use the TMR1H:TMR1L register pair as the time base when operating in Capture or Compare mode.

In Capture mode, the value in the TMR1H:TMR1L register pair is copied into the CCPRxH:CCPRxL register pair on a configured event.

In Compare mode, an event is triggered when the value CCPRxH:CCPRxL register pair matches the value in the TMR1H:TMR1L register pair. This event can be an Auto-conversion Trigger.

The Timer1 to CCP1/2/3/4/5 mapping is not fixed, and can be assigned on an individual CCP module basis. All of the CCP modules may be configured to share a single Timer1 (or Timer3, or Timer5) resource, or different CCP modules may be configured to use different Timer1 resources. This timer to CCP mapping selection is made in the CCPTMRS0 and CCPTMRS1 registers.

For more information, see **Section 30.0 “Capture/Compare/PWM Modules”**.

28.11 CCP Auto-Conversion Trigger

When any of the CCP’s are configured to trigger an auto-conversion, the trigger will clear the TMR1H:TMR1L register pair. This auto-conversion does not cause a timer interrupt. The CCP module may still be configured to generate a CCP interrupt.

In this mode of operation, the CCPRxH:CCPRxL register pair becomes the period register for Timer1.

The timer should be synchronized and FOSC/4 should be selected as the clock source in order to utilize the Auto-conversion Trigger. Asynchronous operation of the timer can cause an Auto-conversion Trigger to be missed.

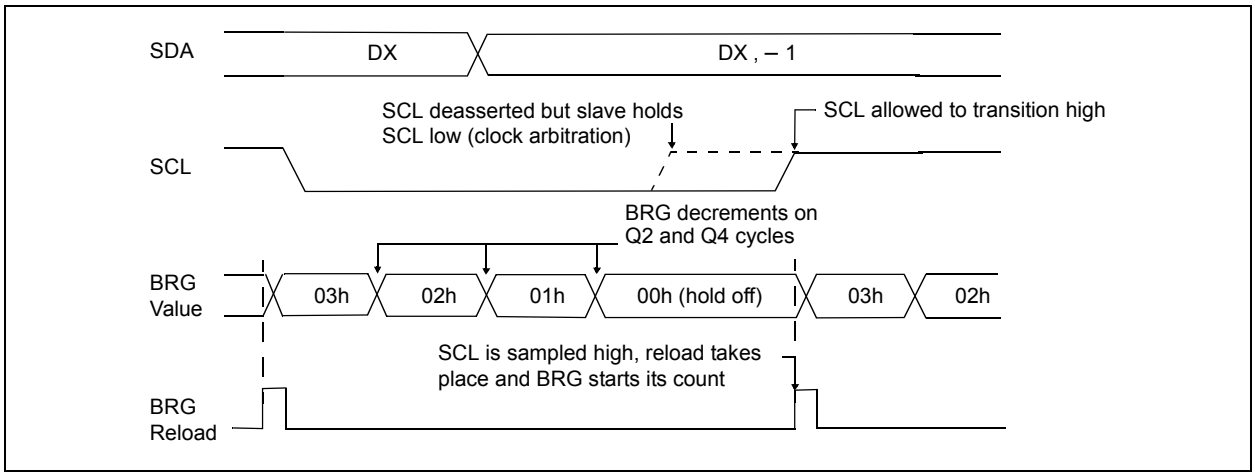
In the event that a write to TMR1H or TMR1L coincides with an Auto-conversion Trigger from the CCP, the write will take precedence.

For more information, see **Section 30.2.4 “Compare During Sleep”**.

31.6.2 CLOCK ARBITRATION

Clock arbitration occurs when the master, during any receive, transmit or Repeated Start/Stop condition, releases the SCL pin (SCL allowed to float high). When the SCL pin is allowed to float high, the Baud Rate Generator (BRG) is suspended from counting until the SCL pin is actually sampled high. When the SCL pin is sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<7:0> and begins counting. This ensures that the SCL high time will always be at least one BRG rollover count in the event that the clock is held low by an external device (Figure 31-25).

FIGURE 31-25: BAUD RATE GENERATOR TIMING WITH CLOCK ARBITRATION



31.6.3 WCOL STATUS FLAG

If the user writes the SSPxBUF when a Start, Restart, Stop, Receive or Transmit sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write does not occur). Any time the WCOL bit is set it indicates that an action on SSPxBUF was attempted while the module was not idle.

Note:	Because queuing of events is not allowed, writing to the lower five bits of SSPxCON2 is disabled until the Start condition is complete.

31.7 BAUD RATE GENERATOR

The MSSP module has a Baud Rate Generator available for clock generation in both I^2C and SPI Master modes. The Baud Rate Generator (BRG) reload value is placed in the SSPxADD register (Register 31-6). When a write occurs to SSPxBUF, the Baud Rate Generator will automatically begin counting down.

Once the given operation is complete, the internal clock will automatically stop counting and the clock pin will remain in its last state.

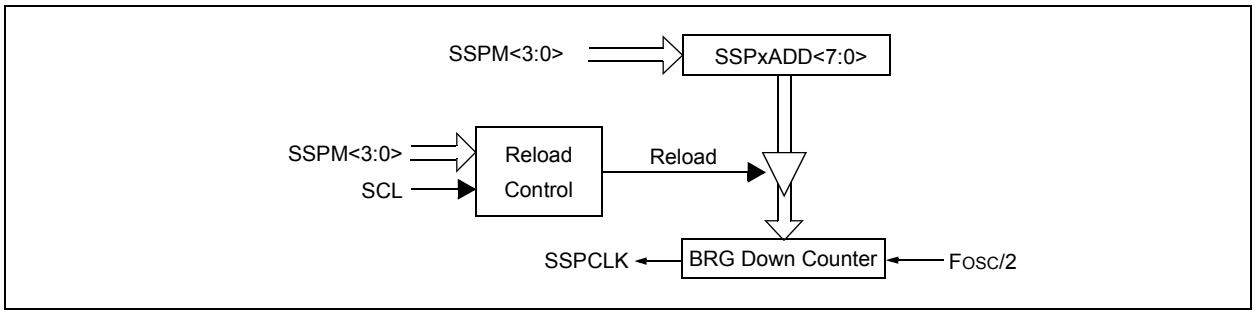
An internal signal “Reload” in Figure 31-40 triggers the value from SSPxADD to be loaded into the BRG counter. This occurs twice for each oscillation of the module clock line. The logic dictating when the reload signal is asserted depends on the mode the MSSP is being operated in.

Table 31-2 demonstrates clock rates based on instruction cycles and the BRG value loaded into SSPxADD.

EQUATION 31-1:

$$F_{CLOCK} = \frac{F_{OSC}}{(SSP1ADD + 1)(4)}$$

FIGURE 31-40: BAUD RATE GENERATOR BLOCK DIAGRAM



Note: Values of 0x00, 0x01 and 0x02 are not valid for SSPxADD when used as a Baud Rate Generator for I^2C. This is an implementation limitation.

TABLE 31-2: MSSP CLOCK RATE W/BRG

FOSC	FCY	BRG Value	FCLOCK (2 Rollovers of BRG)
32 MHz	8 MHz	13h	400 kHz
32 MHz	8 MHz	19h	308 kHz
32 MHz	8 MHz	4Fh	100 kHz
16 MHz	4 MHz	09h	400 kHz
16 MHz	4 MHz	0Ch	308 kHz
16 MHz	4 MHz	27h	100 kHz
4 MHz	1 MHz	09h	100 kHz

Note: Refer to the I/O port electrical specifications in Table 37-4 to ensure the system is designed to support IOL requirements.

REGISTER 32-3: SMTxSTAT: SMT STATUS REGISTER

R/W/HC-0/0	R/W/HC-0/0	R/W/HC-0/0	U-0	U-0	R-0/0	R-0/0	R-0/0
CPRUP	CPWUP	RST	—	—	TS	WS	AS
bit 7							bit 0

Legend:		
HC = Bit is cleared by hardware		HS = Bit is set by hardware
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7 **CPRUP:** SMT Manual Period Buffer Update bit
1 = Request update to SMTxPRx registers
0 = SMTxPRx registers update is complete

bit 6 **CPWUP:** SMT Manual Pulse Width Buffer Update bit
1 = Request update to SMTxCPW registers
0 = SMTxCPW registers update is complete

bit 5 **RST:** SMT Manual Timer Reset bit
1 = Request Reset to SMTxTMR registers
0 = SMTxTMR registers update is complete

bit 4-3 **Unimplemented**: Read as ‘0’

bit 2 **TS:** SMT GO Value Status bit
1 = SMT timer is incrementing
0 = SMT timer is not incrementing

bit 1 **WS:** SMTxWIN Value Status bit
1 = SMT window is open
0 = SMT window is closed

bit 0 **AS:** SMT_signal Value Status bit
1 = SMT acquisition is in progress
0 = SMT acquisition is not in progress

33.4 EUSART Synchronous Mode

Synchronous serial communications are typically used in systems with a single master and one or more slaves. The master device contains the necessary circuitry for baud rate generation and supplies the clock for all devices in the system. Slave devices can take advantage of the master clock by eliminating the internal clock generation circuitry.

There are two signal lines in Synchronous mode: a bidirectional data line and a clock line. Slaves use the external clock supplied by the master to shift the serial data into and out of their respective receive and transmit shift registers. Since the data line is bidirectional, synchronous operation is half-duplex only. Half-duplex refers to the fact that master and slave devices can receive and transmit data but not both simultaneously. The EUSART can operate as either a master or slave device.

Start and Stop bits are not used in synchronous transmissions.

33.4.1 SYNCHRONOUS MASTER MODE

The following bits are used to configure the EUSART for synchronous master operation:

- SYNC = 1
- CSRC = 1
- SREN = 0 (for transmit); SREN = 1 (for receive)
- CREN = 0 (for transmit); CREN = 1 (for receive)
- SPEN = 1

Setting the SYNC bit of the TX1STA register configures the device for synchronous operation. Setting the CSRC bit of the TX1STA register configures the device as a master. Clearing the SREN and CREN bits of the RC1STA register ensures that the device is in the Transmit mode, otherwise the device will be configured to receive. Setting the SPEN bit of the RC1STA register enables the EUSART.

33.4.1.1 Master Clock

Synchronous data transfers use a separate clock line, which is synchronous with the data. A device configured as a master transmits the clock on the TX/CK line. The TX/CK pin output driver is automatically enabled when the EUSART is configured for synchronous transmit or receive operation. Serial data bits change on the leading edge to ensure they are valid at the trailing edge of each clock. One clock cycle is generated for each data bit. Only as many clock cycles are generated as there are data bits.

33.4.1.2 Clock Polarity

A clock polarity option is provided for Microwire compatibility. Clock polarity is selected with the SCKP bit of the BAUD1CON register. Setting the SCKP bit sets the clock Idle state as high. When the SCKP bit is set, the data changes on the falling edge of each clock. Clearing the SCKP bit sets the Idle state as low. When the SCKP bit is cleared, the data changes on the rising edge of each clock.

33.4.1.3 Synchronous Master Transmission

Data is transferred out of the device on the RX/DT pin. The RX/DT and TX/CK pin output drivers are automatically enabled when the EUSART is configured for synchronous master transmit operation.

A transmission is initiated by writing a character to the TXREG register. If the TSR still contains all or part of a previous character the new character data is held in the TXREG until the last bit of the previous character has been transmitted. If this is the first character, or the previous character has been completely flushed from the TSR, the data in the TXREG is immediately transferred to the TSR. The transmission of the character commences immediately following the transfer of the data to the TSR from the TXREG.

Each data bit changes on the leading edge of the master clock and remains valid until the subsequent leading clock edge.

Note:	The TSR register is not mapped in data memory, so it is not available to the user.

33.4.1.4 Synchronous Master Transmission Set-up:

1. Initialize the SPBRGH, SPBRGL register pair and the BRGH and BRG16 bits to achieve the desired baud rate (see **Section 33.3 “EUSART Baud Rate Generator (BRG)”**).
2. Enable the synchronous master serial port by setting bits SYNC, SPEN and CSRC.
3. Disable Receive mode by clearing bits SREN and CREN.
4. Enable Transmit mode by setting the TXEN bit.
5. If 9-bit transmission is desired, set the TX9 bit.
6. If interrupts are desired, set the TXIE bit of the PIE3 register and the GIE and PEIE bits of the INTCON register.
7. If 9-bit transmission is selected, the ninth bit should be loaded in the TX9D bit.
8. Start transmission by loading data to the TXREG register.

37.0 ELECTRICAL SPECIFICATIONS

37.1 Absolute Maximum Ratings(†)

Ambient temperature under bias ..... -40°C to +125°C
Storage temperature ..... -65°C to +150°C
Voltage on pins with respect to V_{SS}
- on V_{DD} pin
  - PIC16F18856/76 ..... -0.3V to +6.5V
  - PIC16LF18856/76 ..... -0.3V to +4.0V
- on $\overline{MCLR}$ pin ..... -0.3V to +9.0V
- on all other pins ..... -0.3V to (V_{DD} + 0.3V)

Maximum current
- on V_{SS} pin(1)
  - -40°C ≤ T_A ≤ +85°C ..... 350 mA
  - 85°C < T_A ≤ +125°C ..... 120 mA
- on V_{DD} pin for 28-Pin devices(1)
  - -40°C ≤ T_A ≤ +85°C ..... 250 mA
  - 85°C < T_A ≤ +125°C ..... 85 mA
- on V_{DD} pin for 40-Pin devices(1)
  - -40°C ≤ T_A ≤ +85°C ..... 350 mA
  - 85°C < T_A ≤ +125°C ..... 120 mA
- on any standard I/O pin ..... ±50 mA

Clamp current, I_K (V_{PIN} < 0 or V_{PIN} > V_{DD}) ..... ±20 mA
Total power dissipation(2) ..... 800 mW

Note 1: Maximum current rating requires even load distribution across I/O pins. Maximum current rating may be limited by the device package power dissipation characterizations, see Table 37-6 to calculate device specifications.

2: Power dissipation is calculated as follows:

$$P_{DIS} = V_{DD} \times \{I_{DD} - \Sigma I_{OH}\} + \Sigma \{(V_{DD} - V_{OH}) \times I_{OH}\} + \Sigma (V_{OI} \times I_{OL})$$

† NOTICE: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure above maximum rating conditions for extended periods may affect device reliability.

Note: Unless otherwise noted, VIN = 5V, FOSC = 300 kHz, CIN = 0.1 µF, TA = 25°C.

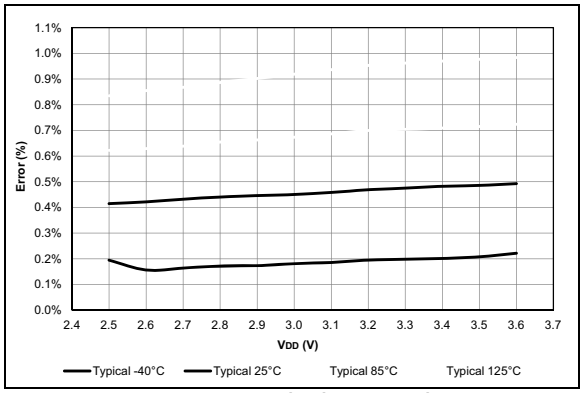


FIGURE 38-73: *Typical FVR Voltage 1x, PIC16LF18856/76 Only.*

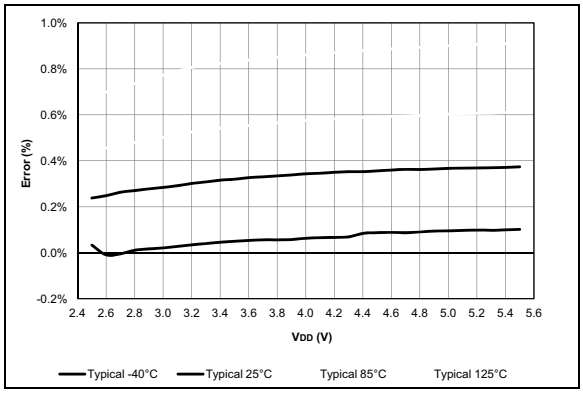


FIGURE 38-76: *FVR Voltage Error 2x, PIC16F18856/76 Only.*

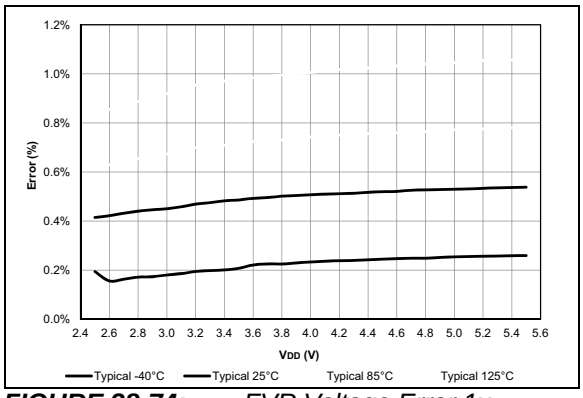


FIGURE 38-74: *FVR Voltage Error 1x, PIC16F18856/76 Only.*

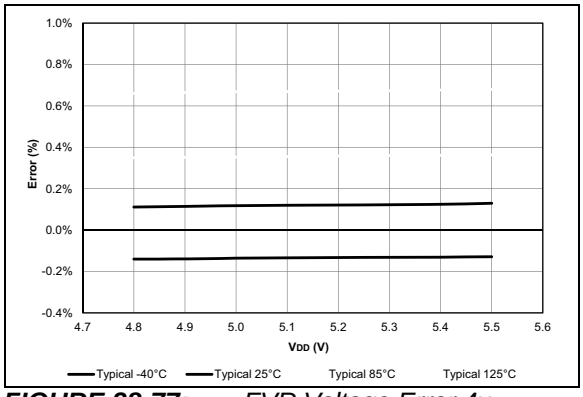


FIGURE 38-77: *FVR Voltage Error 4x, PIC16F18856/76 Only.*

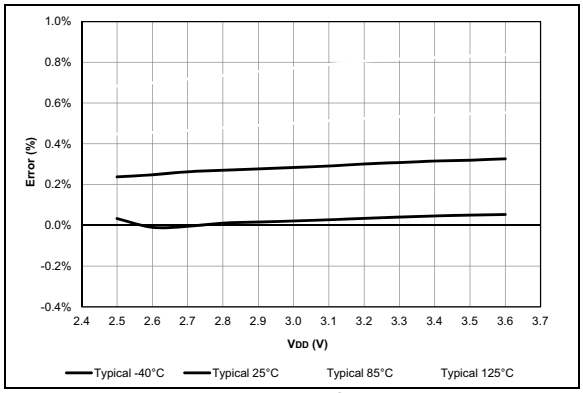


FIGURE 38-75: *FVR Voltage Error 2x, PIC16LF18856/76 Only.*

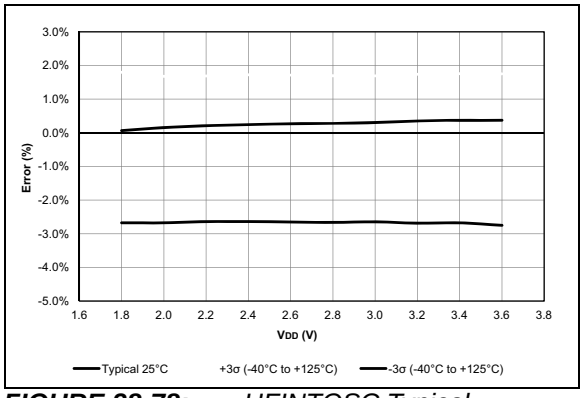
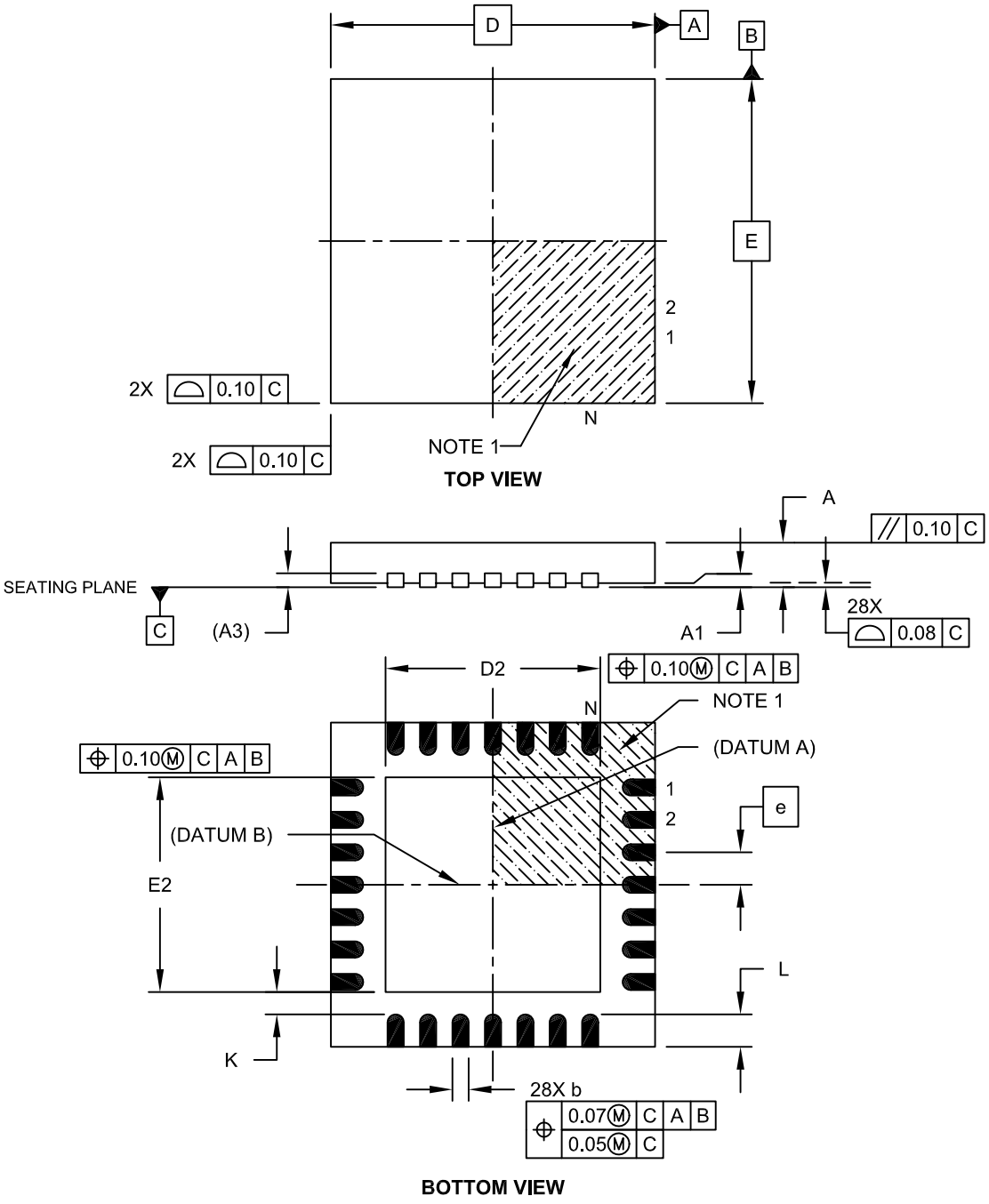


FIGURE 38-78: *HFINTOSC Typical Frequency Error, PIC16LF18856/76 Only.*

28-Lead Plastic Ultra Thin Quad Flat, No Lead Package (MV) – 4x4x0.5 mm Body [UQFN]

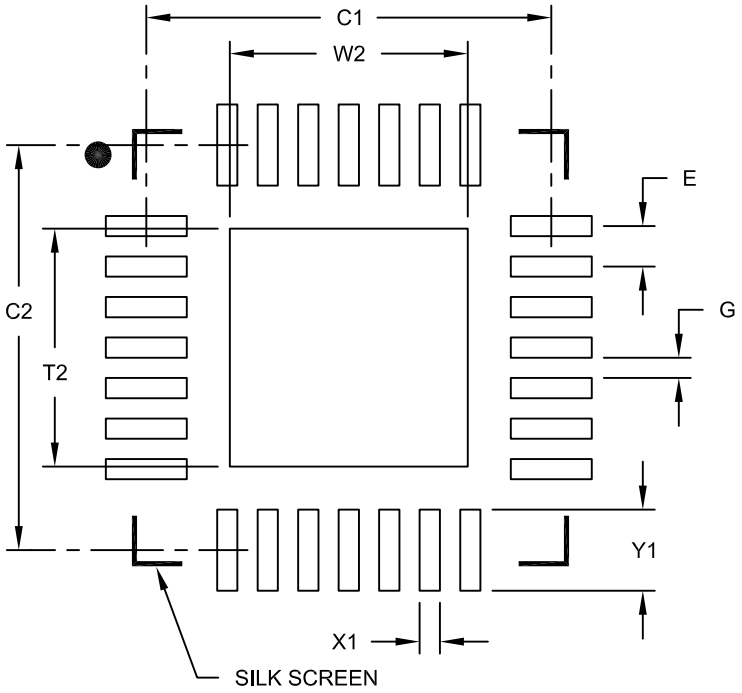
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-152A Sheet 1 of 2

28-Lead Ultra Thin Plastic Quad Flat, No Lead Package (MV) - 4x4 mm Body [UQFN]
With 0.40 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.40 BSC	
Optional Center Pad Width	W2			2.35
Optional Center Pad Length	T2			2.35
Contact Pad Spacing	C1		4.00	
Contact Pad Spacing	C2		4.00	
Contact Pad Width (X28)	X1			0.20
Contact Pad Length (X28)	Y1			0.80
Distance Between Pads	G	0.20		

Notes:

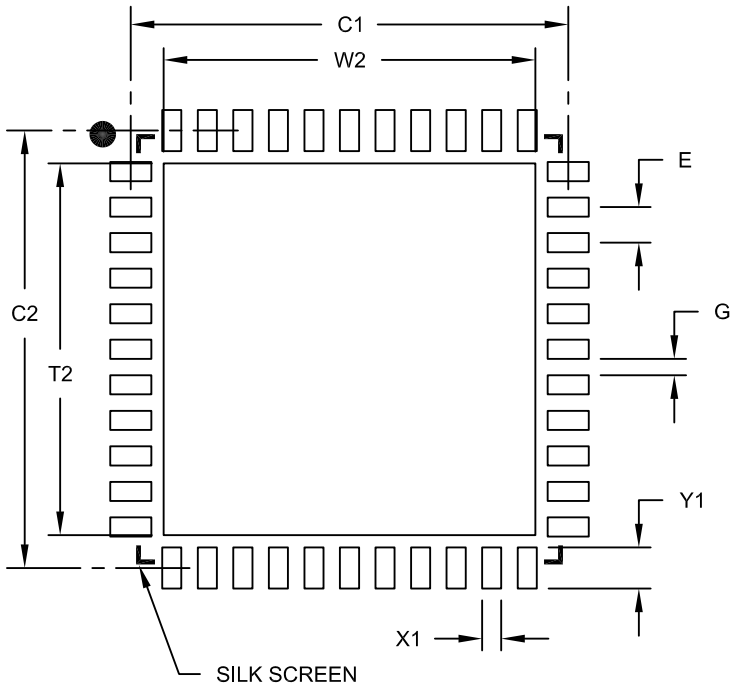
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2152A

44-Lead Plastic Quad Flat, No Lead Package (ML) - 8x8 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.65 BSC	
Optional Center Pad Width	W2			6.60
Optional Center Pad Length	T2			6.60
Contact Pad Spacing	C1		8.00	
Contact Pad Spacing	C2		8.00	
Contact Pad Width (X44)	X1			0.35
Contact Pad Length (X44)	Y1			0.85
Distance Between Pads	G	0.25		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2103B